



**RFP 140919**

**TSTC – SH 130 Monument Sign – Design/Build**

**Addendum #1**

**Posted Date: 10-07-14**

## **Clarifications**

The purpose for this addendum is to provide clarifications and revisions to RFP 140919

- **Structural plans shall be stamped by licensed professional engineer.**
- **A design review meeting will be held at the 50% design stage.**
- **Existing conduit for Electrical Option A is 24-36" below grade. Backfilled with normal fill. No concrete encasement.**

Please sign and date below and attach addendum to the bid package submitted.

I, by signing below acknowledge receipt of the posted addenda, and understand that it becomes part of the bid package for submission.

Signature: \_\_\_\_\_

Date: \_\_\_\_\_